

Product Discontinuation Notice: XC17S00A OTP Configuration PROMs in VO(G)8 Package Products

XCN13019 (v1.0) June 24, 2013

Product Discontinuation Notice

#### Overview

The purpose of this notification is to communicate that Xilinx is discontinuing XC17S00A OTP Configuration PROMs in VO(G)8 package products. This product discontinuance notice (PDN) applies to both **Commercial (C)** and **Industrial (I)** temperature grade products.

## Description

Xilinx assembly suppliers are discontinuing their assembly line that manufactures the VO8 and VOG8 packages we source for the XC17S00A OTP Configuration PROMs. These PROMs are used to configure the Xilinx Spartan®-II/-IIE FPGA family devices. There are no pin compatible replacements for these affected devices. Customers are encouraged to place a last time buy to support their lifetime demand or alternatively the PD8, PDG8 and SO20 packages supported in this XC17S00A family are still available in production.

This notice should be used in conjunction with previous discontinuance notices which can be found at Xilinx.com.

### **Products Affected**

The products affected include all standard part numbers and specification control document (SCD) versions of the standard part numbers listed in Table 1.

Part Number	Replacement Part	Part Number	Replacement Part
XC17S100AVO8C	No direct replacement	XC17S200AVO8I	No direct replacement
XC17S100AVO8I	No direct replacement	XC17S200AVOG8C	No direct replacement
XC17S100AVOG8C	No direct replacement	XC17S200AVOG8I	No direct replacement
XC17S150AVO8C	No direct replacement	XC17S30AVO8C	No direct replacement
XC17S150AVO8I	No direct replacement	XC17S30AVO8I	No direct replacement
XC17S15AVO8C	No direct replacement	XC17S50AVO8C	No direct replacement
XC17S15AVO8I	No direct replacement	XC17S50AVO8I	No direct replacement
XC17S15AVOG8C	No direct replacement	XC17S50AVOG8C	No direct replacement
XC17S200AVO8C	No direct replacement	XC17S100AVO8C0100	No direct replacement

#### Table 1: Configuration Solutions PROMs Family Products Affected

### **Key Dates and Ordering Information**

Final orders are accepted until June 15, 2014.

Regardless of the date an order was placed, an order that remains open on or after April 15, 2014 will be deemed Non-Cancellable, Non-Returnable (NCNR).

Final deliveries must occur on or before December 15, 2014.

Return Material Authorizations (RMAs) for replacement devices due to quality issues will be accepted until June 15, 2015.

# **Technical Support**

For Technical Support on these products refer to Solution Center <u>Xilinx Answer Record 40174</u>. Support for these products will be limited to tools usage and existing documentation.

### Response

Customers are requested to place last-time-buy orders in a timely manner prior to the key dates listed above to avoid product availability issues. If you anticipate that your last time buy requirements will exceed the current rate, please provide your Xilinx Sales Representative with a forecast of the requirements. All orders will be supported on a first-come, first-served basis. All orders placed within 60 days of the last time buy date will be non-cancellable and non-returnable (NCNR). For additional information or questions, contact your local Xilinx Sales representative.

**Important Notice**: Xilinx Customer Notifications (XCNs, XDNs, and Quality Alerts) can be delivered via e-mail alerts sent by the Support website (<u>http://www.xilinx.com/support</u>). Register today and personalize your "Documentation and Design Advisory Alerts" area to include Customer Notifications. Xilinx Support provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, etc. For information on how to sign up, refer to Xilinx Answer Record 18683.

#### **Revision History**

The following table shows the revision history for this document.

Date	Version	Revision
6/24/2013	1.0	Initial release.

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